

FEATURES

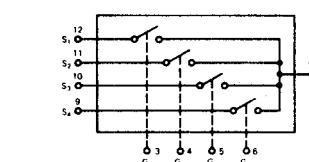
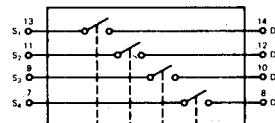
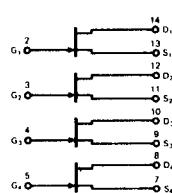
- $r_{DS(ON)} < 10$ ohms: G1340 and G1360
- $I_{D(OFF)} < 50$ pA: G125, G126, G129 and G130
- $C_{DG}, C_{SG} < 2$ pF: G125, G126, G129 and G130

GENERAL DESCRIPTION

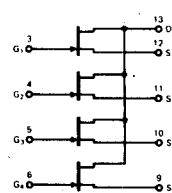
These switches consist of four N-Channel Junction FETs in a single package. In the G129, G130, G131, G132, G1350 and G1360 the drains are common to assist the designer in applications such as multiplexing.

PIN CONFIGURATIONS (Outline dwgs DD, FD-2, JD)

G125, G126,
G127, G128
G1330 AND G1340



G129, G130,
G131, G132
G1350 AND G1360

**ELECTRICAL CHARACTERISTICS** per channel (25°C unless otherwise noted)

CHARACTERISTIC	TEST CONDITIONS		G125 G129	G126 G130	G127 G131	G128 G132	G1330 G1350	G1340 G1360	UNIT	LIMIT
I_{GSS}	Gate Reverse Current	$V_{GS} = -20\text{V}$, $V_{DS} = 0$	25°C 125°C	-0.1	-0.1	-0.2	-0.2	-5.0	-5.0	nA
BV_{GSS}	Gate-Source Break-down Voltage	$I_G = -1 \mu\text{A}$, $V_{DS} = 0$		-40	-40	-40	-40	-30	-30	μA
V_P	Gate-Source Pinch-Off Voltage	$V_{DS} = 10\text{V}$, $I_D = 0.1 \mu\text{A}$	-5	-10	-5	-10	-5	-10	V	Max
$I_{D(OFF)}$	Drain Cutoff Current	$V_{DS} = 10\text{V}$ $V_{GS} = -10\text{V}$	25°C 125°C	0.05	0.05	0.1	0.1	0.5	0.5	nA
$I_{S(OFF)}$	Source Cutoff Current	$V_{SD} = 10\text{V}$ $V_{GD} = -10\text{V}$		0.05	0.05	0.1	0.1	0.5	0.5	μA
I_{DSZ}	Drain Current at Zero Gate Voltage	$V_{DS} = 10\text{V}$, $V_{GS} = 0$ (Pulsed)	0.5	2	5	10	15	30	mA	Min
r_{DS}	Drain-Source ON Resistance	$V_{GS} = 0$, $I_D = 0$, $f = 1\text{ kHz}$	500	250	90	45	20	10	Ω	Max
$C_{DG} + C_{SG}$	Gate-Source plus Gate-Drain ON Capacitance	$V_{GS} = 0$, $V_{DS} = 0$, $f = 1\text{ MHz}$	10	10	40	40	300	300	pF	Max
C_{DG}	Drain-Gate OFF Capacitance	$V_{GS} = -10\text{V}$, $V_{DS} = 0$, $f = 1\text{ MHz}$	2	2	7	7	16	16	pF	Max
C_{SG}	Source-Gate OFF Capacitance		2	2	7	7	16	16	pF	Max

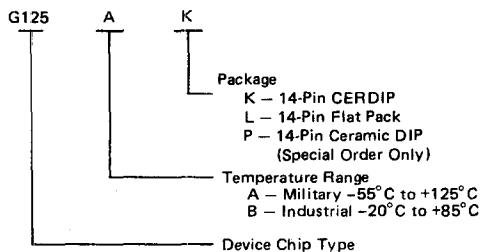
ABSOLUTE MAXIMUM RATINGS

Gate-Drain or Gate-Source Voltage	-40V
Gate Current	50 mA
Total Device Dissipation Free Air (Note)	500 mW
Storage Temperature Range	-65 to +150°C
Operating Temperature	-65 to +150°C
Lead Temperature (Soldering, 10 sec)	300°C

NOTE: Dissipation rating assumes device is mounted with all leads welded or soldered to printed circuit board in ambient temperature below 75°C. For higher temperatures, derate the device at the rate of 6.7 mW/°C.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

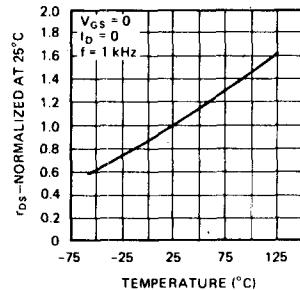
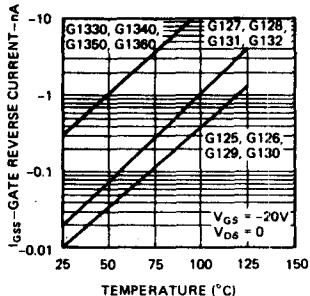
ORDERING INFORMATION



NOTE: Ceramic DIP available for military temperature range only.

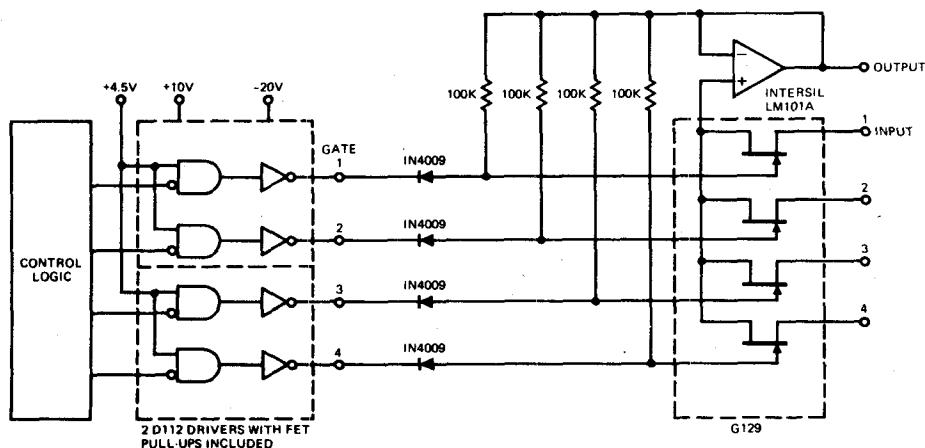
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TYPICAL CHARACTERISTICS



APPLICATION

4-Channel Commutator Circuit



INPUT RANGE: -10 to +10V
GATE: LOGIC "1" FOR SWITCH ON
LOGIC "0" FOR SWITCH OFF